## Status of Mechanical Mockups and Tests

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Max-Planck-Institut für Physik (Werner-Heisenberg-Institut) Mechanical Design First Mechanical Mockup First glueing tests Ideas on Thermal Mechanical Tests Conclusions

Mechanical Design	First Mechanical Mockup	First glueing tests	Ideas on Thermal Mechanical Tests	Conclusions
Mechanical	Design			

Input from Prague when using springs:

- thermal contact might be problematic
- thermal grease might be to adhesive for gliding
- investigation to screw modules onto support
- thermal expansion of silicon very small ( $\approx 20 \,\mu m$  for  $\Delta T = 50 \,^{\circ} K$ )
- one support end fixed to beampipe, other end gliding along beampipe

### Advantages

- good thermal support possible
- no relative movement between modules
- easier isolation between support and modules

#### Issues

- stress on modules if not all are working
- electric discharge manufacturing not possible currently only steel possible

Mechanical Design	First Mechanical Mockup	First glueing tests	Ideas on Thermal Mechanical Tests	Conclusions
First Mech	anical Mockup			

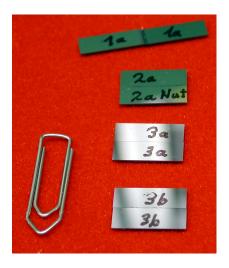
- unthinned dummies avaiable
- first inner layer assembly successful







## First glueing tests



- first face to face glueing tests started
- no estimates on stabilities yet, but very promising results, even without reinforcements
- first sketch for glueing of final modules under evaluation

Mechanical Design

First Mechanical Mockup

First glueing tests

# Ideas on Thermal Mechanical Tests

Planned tests include:

- movement of modules under thermal cycling using spring solution
- deformation/stress of modules using screwing solution
- stability of glueing

Suggested temperature range:

- $\blacktriangleright~-10\,^\circ\text{C}$  to 30  $^\circ\text{C}$  normal usage
- $\blacktriangleright~-30\,^{\circ}\text{C}$  to 60  $^{\circ}\text{C}$  maximal range

Required precision:  $<5\,\mu\text{m}$  when measuring  $\Delta\,T=5\,^\circ\text{C}$  steps

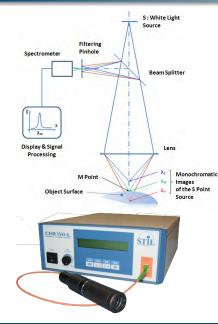


Mechanical Design

First Mechanical Mockup

First glueing tests

# Confocal Chromatic Displacement Sensors



- contact free, optical measurement
- almost independent of material (specular, diffuse)
- high precision
- passive sensor, works in large temperature range (without condensation effects -25 °C to 120 °C)

## Promising, but...

- rather expensive
- ► maximum object slope ≈ 20 ° for specular surfaces

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Alternatives				

Laser Triangulation

- should be cheaper
- $\blacktriangleright$  works only with diffuse materials, otherwise maximal tilt is  $< 0.1\,^\circ$
- specified temperature range of  $0^{\circ}$ C to  $50^{\circ}$ C,

Microscope and alignment structures

- measurement of deformations difficult
- microscope has to be installed in climate chamber

Mechanical Design	First Mechanical Mockup	First glueing tests	Ideas on Thermal Mechanical Tests	Conclusions
Conclusions				

- new fixation scheme under evaluation
- first mechanical mockup well underway
- first glueing tests have started
  - surprisingly strong, even without reinforcement
- plans for module tests underway
  - Confocal Chromatic Displacement looks promising, but expensive